

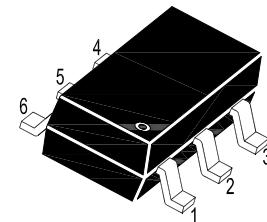
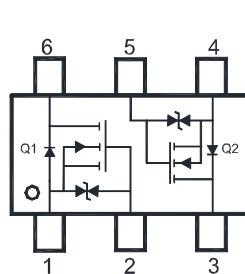
# MMBT7002KD-AH

## Dual N-Channel Enhancement Mode MOSFET

### Features

- AEC-Q101 Qualified
- Low on resistance  $R_{DS(ON)}$
- Low gate threshold voltage
- Low input capacitance
- Halogen and Antimony Free(HAF), RoHS compliant
- Typical ESD Protection HBM Class 2

| Classification | Voltage Range(V) |
|----------------|------------------|
| 0A             | < 125            |
| 0B             | 125 to < 250     |
| 1A             | 250 to < 500     |
| 1B             | 500 to < 1000    |
| 1C             | 1000 to < 2000   |
| 2              | 2000 to < 4000   |
| 3A             | 4000 to < 8000   |
| 3B             | $\geq 8000$      |



1. Source 2. Gate 3. Drain  
4. Source 5. Gate 6. Drain  
SOT-26 Plastic Package

### Application

- Portable appliances
- Battery management

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ ) (Q1\Q2)

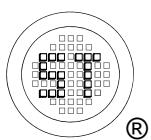
| Parameter                                | Symbol         | Value         | Unit |
|--|----------------|---------------|------|
| Drain Source Voltage                     | $V_{DS}$       | 60            | V    |
| Gate Source Voltage                      | $V_{GS}$       | $\pm 20$      | V    |
| Drain Current                            | $I_D$          | 300           | mA   |
| Peak Drain Current, Pulsed <sup>1)</sup> | $I_{DM}$       | 1             | A    |
| Power Dissipation                        | $P_{tot}$      | 350           | mW   |
| Operating and Storage Temperature Range  | $T_j, T_{stg}$ | - 55 to + 150 | °C   |

### Thermal Resistance Ratings

| Parameter   | Symbol          | Max. | Unit |
|---|-----------------|------|------|
| Thermal Resistance from Junction to Ambient <sup>2)</sup> | $R_{\theta JA}$ | 357  | °C/W |

<sup>1)</sup> Pulse Test: Pulse Width  $\leq 100 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ , Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ .

<sup>2)</sup> Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.



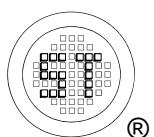
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Characteristics at  $T_a = 25^\circ\text{C}$  unless otherwise specified(Q1\Q2)

| Parameter  | Symbol                      | Min. | Typ. | Max.     | Unit          |
|--|-----------------------------|------|------|----------|---------------|
| Drain Source Breakdown Voltage<br>at $I_D = 10 \mu\text{A}$  | $V_{(\text{BR})\text{DSS}}$ | 60   | -    | -        | V             |
| Zero Gate Voltage Drain Current<br>at $V_{DS} = 60 \text{ V}$  | $I_{DSS}$                   | -    | -    | 1        | $\mu\text{A}$ |
| Gate Source Leakage Current<br>at $V_{GS} = \pm 20 \text{ V}$  | $I_{GSS}$                   | -    | -    | $\pm 10$ | $\mu\text{A}$ |
| Gate Source Threshold Voltage<br>at $V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$  | $V_{GS(\text{th})}$         | 1    | -    | 2.5      | V             |
| Static Drain Source On-State Resistance<br>at $V_{GS} = 10 \text{ V}$ , $I_D = 500 \text{ mA}$<br>at $V_{GS} = 4.5 \text{ V}$ , $I_D = 200 \text{ mA}$ | $R_{DS(\text{on})}$         | -    | -    | 3        | $\Omega$      |
| <b>DYNAMIC PARAMETERS</b>  |                             |      |      |          |               |

|   |                     |    |      |   |          |
|---|---------------------|----|------|---|----------|
| Forward Transconductance<br>at $V_{DS} = 10 \text{ V}$ , $I_D = 200 \text{ mA}$   | $g_{FS}$            | 80 | -    | - | mS       |
| Gate Resistance<br>at $V_{GS} = 0 \text{ V}$ , $V_{DS} = 0 \text{ V}$ , $f = 1\text{MHz}$                               | $R_g$               | -  | 200  | - | $\Omega$ |
| Input Capacitance<br>at $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$                          | $C_{iss}$           | -  | 21   | - | pF       |
| Output Capacitance<br>at $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$                         | $C_{oss}$           | -  | 12   | - | pF       |
| Reverse Transfer Capacitance<br>at $V_{GS} = 0 \text{ V}$ , $V_{DS} = 25 \text{ V}$ , $f = 1 \text{ MHz}$               | $C_{rss}$           | -  | 0.35 | - | pF       |
| Gate charge total<br>at $V_{DS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $V_{GS} = 4.5 \text{ V}$                      | $Q_g$               | -  | 0.4  | - | nC       |
| Gate to Source Charge<br>at $V_{DS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $V_{GS} = 4.5 \text{ V}$                  | $Q_{gs}$            | -  | 0.2  | - | nC       |
| Gate to Drain Charge<br>at $V_{DS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $V_{GS} = 4.5 \text{ V}$                   | $Q_{gd}$            | -  | 0.1  | - | nC       |
| Turn-On Delay Time<br>at $V_{DS} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $R_G = 25 \Omega$  | $t_{d(\text{on})}$  | -  | 2.7  | - | ns       |
| Turn-On Rise Time<br>at $V_{DS} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $R_G = 25 \Omega$   | $t_r$               | -  | 2.5  | - | ns       |
| Turn-Off Delay Time<br>at $V_{DS} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $R_G = 25 \Omega$ | $t_{d(\text{off})}$ | -  | 13   | - | ns       |
| Turn-Off Fall Time<br>at $V_{DS} = 30 \text{ V}$ , $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \text{ A}$ , $R_G = 25 \Omega$  | $t_f$               | -  | 8    | - | ns       |

| Body-Diode PARAMETERS  |          |   |      |     |    |
|--|----------|---|------|-----|----|
| Drain-Source Diode Forward Voltage<br>at $V_{GS} = 0 \text{ V}$ , $I_S = 0.5 \text{ A}$                | $V_{SD}$ | - | 0.85 | -   | V  |
| Body-Diode Continuous Current  | $I_S$    | - | -    | 300 | mA |
| Body Diode Reverse Recovery Time<br>at $I_S = 0.5 \text{ A}$ , $di/dt = 100 \text{ A} / \mu\text{s}$   | $t_{rr}$ | - | 30   | -   | ns |
| Body Diode Reverse Recovery Charge<br>at $I_S = 0.5 \text{ A}$ , $di/dt = 100 \text{ A} / \mu\text{s}$ | $Q_{rr}$ | - | 29   | -   | nC |



# MMBT7002KD-AH

## Electrical Characteristics Curves(Q1/Q2)

Fig. 1 Typical Output Characteristic

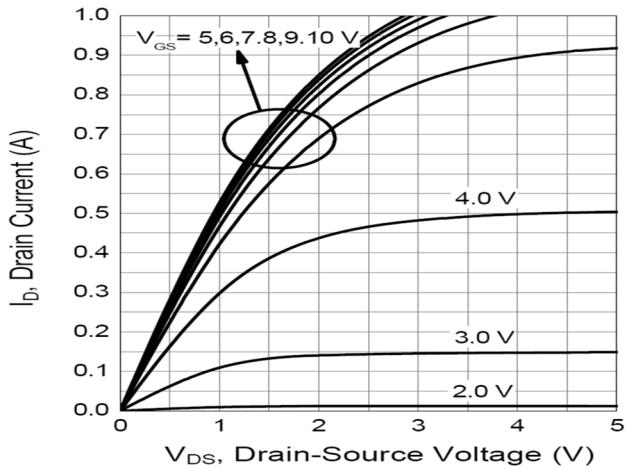


Fig. 2 Gate Threshold Variation vs.  $T_j$

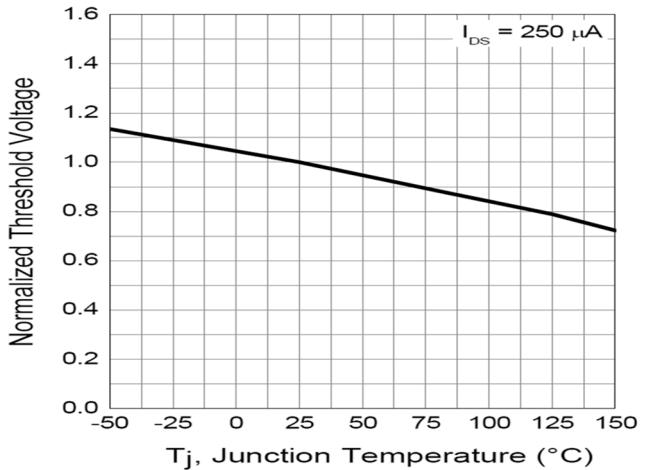


Fig. 3  $R_{DS(on)}$  vs. Gate-Source Voltage

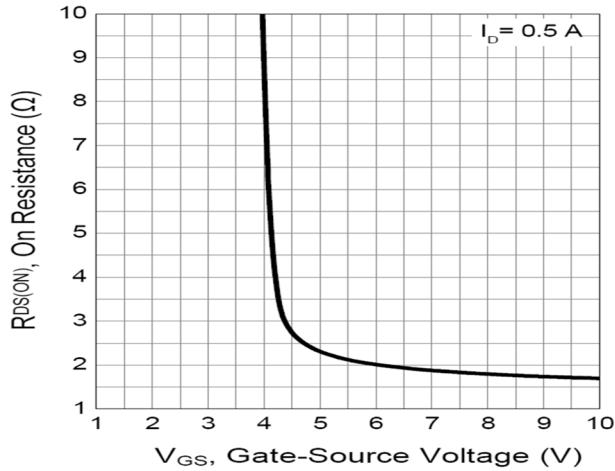


Fig. 4 on-Resistance vs. $T_j$

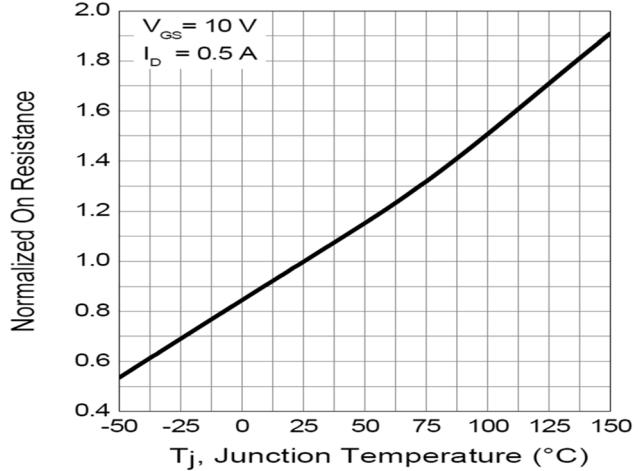


Fig. 5 on-Resistance vs. Drain Current

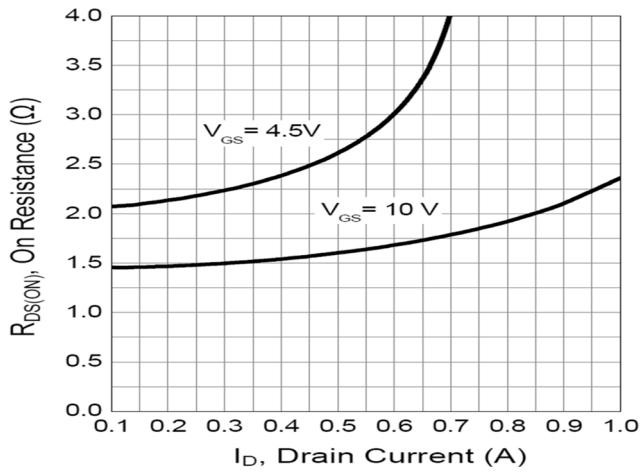
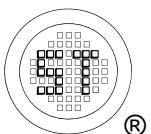
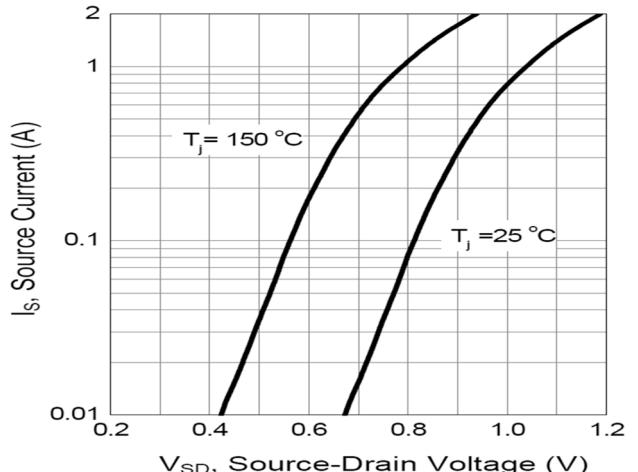


Fig. 6 Typical Forward Characteristic



# MMBT7002KD-AH

## Electrical Characteristics Curves(Q1\Q2)

Fig. 7 Typical Junction Capacitance

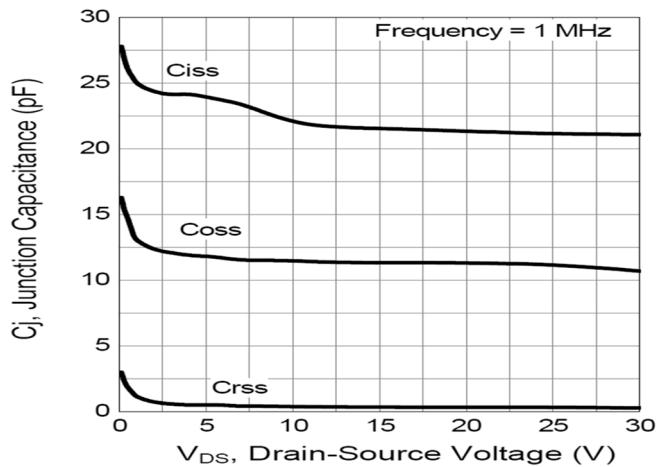
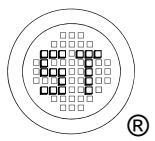
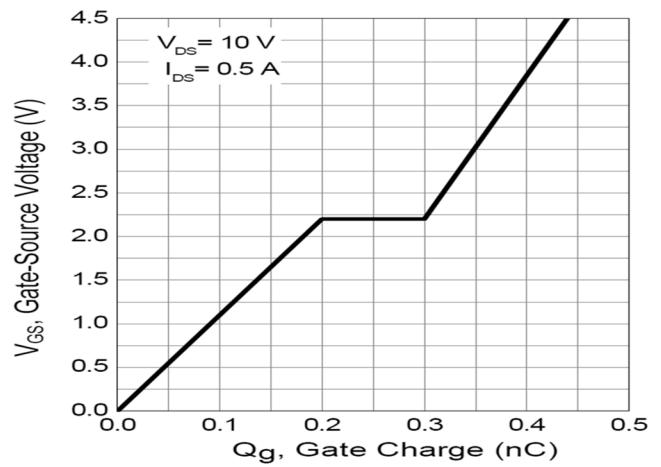


Fig. 8 Gate Charge



## Test Circuits

Fig.1-1 Switching times test circuit

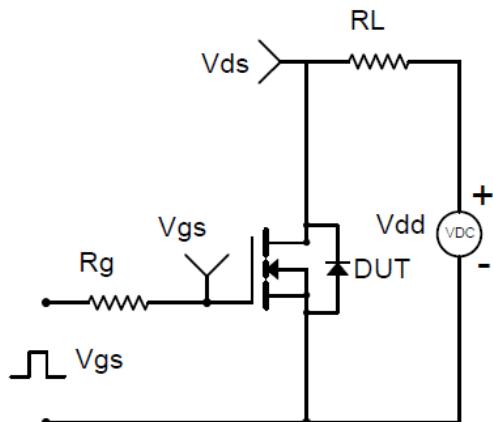


Fig.1-2 Switching Waveform

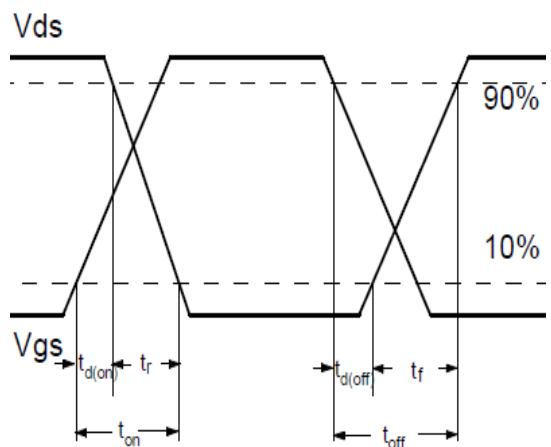


Fig.2-1 Gate charge test circuit

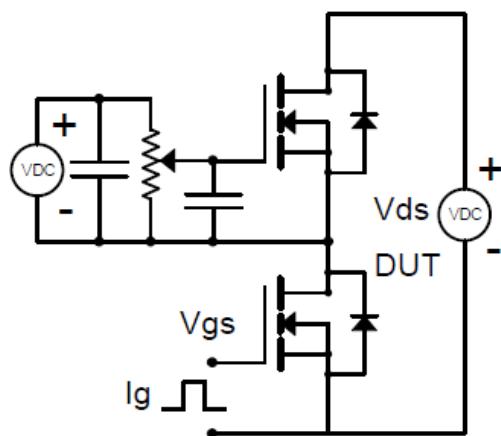
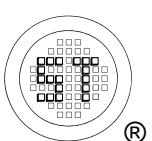
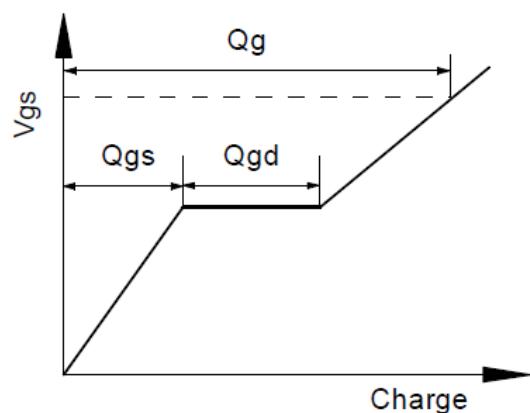


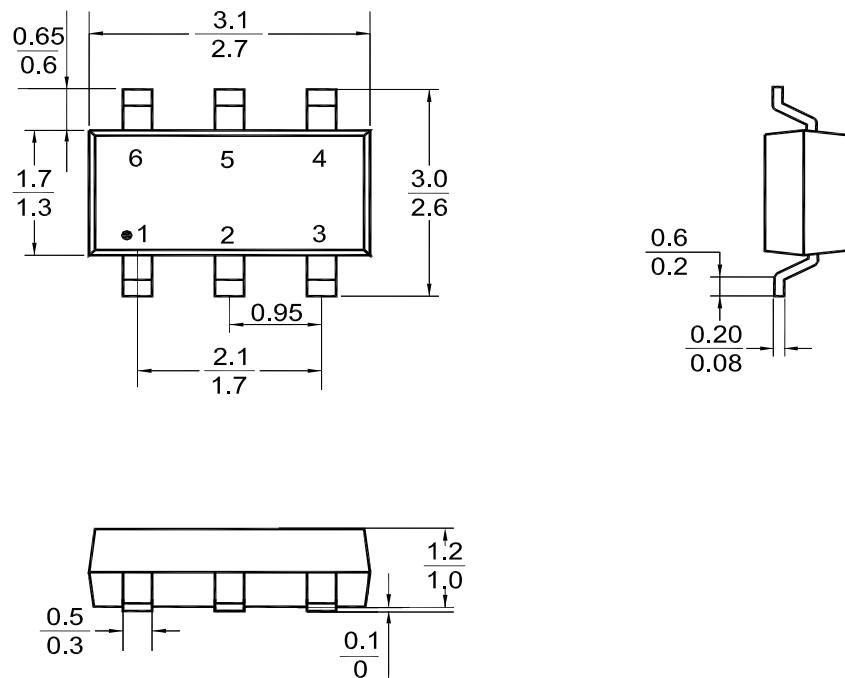
Fig.2-2 Gate charge waveform



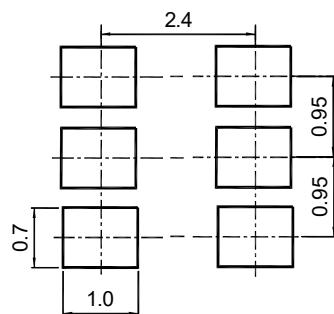
# MMBT7002KD-AH

## Package Outline Dimensions (Units: mm)

SOT-26



## Recommended Soldering Footprint



## Packing information

| Package | Tape Width<br>(mm) | Pitch   |               | Reel Size |      | Per Reel Packing Quantity |
|---------|--------------------|---------|---------------|-----------|------|---------------------------|
|         |                    | mm      | inch          | mm        | inch |                           |
| SOT-26  | 8                  | 4 ± 0.1 | 0.157 ± 0.004 | 178       | 7    | 3,000                     |

## Marking information

- " K712 " = Part No.
- " • " = HAF (Halogen and Antimony Free)
- "YM" = Date Code Marking
- "Y" = Year
- "M" = Month
- Font type: Arial

